APPLICATION DATA SHEET

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Application Information:

Title of Invention: METHOD FOR MAKING JUNCTION AND PROCESSED

MATERIAL FORMED USING THE SAME

Application Type: regular, utility

Attorney Docket Number: 40201

Botanic Information:

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Representative Information:

practitioner(s) at Customer Number:

52054 *52054*

as our attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected

therewith.

Domestic Priority Information:

This is a National Stage of WO application number PCT/JP2004/015308, filed 2004-10-08.

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Doc.No:2003-350368; Country - JP; Date: 2003-10-09 us-priority-claimed

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